

AP09N90CW-HF-VB Datasheet N-Channel 900V (D-S) Super Junction Power MOSFET

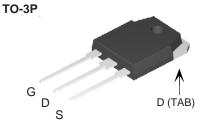
PRODUCT SUMMARY			
V _{DS} (V) at T _J max.	900		
R _{DS(on)} at 25 °C (Ω)	V _{GS} = 10 V	0.75	
Q _g max. (nC)	20		
Q _{gs} (nC)	2.4		
Q _{gd} (nC)	11		
Configuration	Single		

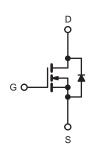
FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial





N-Channel MOSFET

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	900	V
Gate-Source Voltage			V _{GS}	± 30	7 v
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C		9	А
	V _{GS} at 10 V	$T_C = 100 ^{\circ}C$	I _D	7.3	
Pulsed Drain Current ^a			I _{DM}	28	
Linear Derating Factor				1.89	W/°C
Single Pulse Avalanche Energy b			E _{AS}	86	mJ
Maximum Power Dissipation			P _D	109	W
Operating Junction and Storage Temperature Rang	е		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	$T_{J} = 1$	25 °C	dV/dt	50	V/ns
Reverse Diode dV/dt ^d		αν/αι	3.2	V/IIS	
Soldering Recommendations (Peak Temperature) c	for	10 s		300	°C

- a. Repetitive rating; pulse width limited by maximum junction temperature. b. $V_{DD}=50$ V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.5 A.

- c. 1.6 mm from case. d. $I_{SD} \le I_D$, dl/dt = 100 A/ μ s, starting $T_J = 25$ °C.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	72	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	0.7]	

PARAMETER	SYMBOL	TES	TEST CONDITIONS			MAX.	UNIT
Static				•	•	•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		900	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	Reference to 25 °C, I _D = 1 mA		0.65	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$		2	-	4	V
		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I_{GSS}		V _{GS} = ± 30 V		-	± 1	μA
			$V_{DS} = 900 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}		V _{DS} =620 V, V _{GS} = 0 V, T _J = 125 °C		-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 6 A	-	0.75	-	Ω
Forward Transconductance	9 _{fs}	V _{DS} = 30 V, I _D = 6 A		-	19	-	S
Dynamic				•	•	•	
Input Capacitance	C _{iss}	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1 MHz		-	373	-	pF
Output Capacitance	C _{oss}			-	26	-	
Reverse Transfer Capacitance	C _{rss}			-	14	-	
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	46	-	
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg			-	26		
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_{D} = 6 \text{ A}, V_{DS} = 520 \text{ V}$		-	2.1	-	nC
Gate-Drain Charge	Q _{gd}	1		-	2.8	-	1
Turn-On Delay Time	t _{d(on)}	$V_{DD} = 620 \text{ V}, I_{D} = 6 \text{ A}, V_{GS} = 10 \text{ V}, R_{g} = 9.1 \Omega$		-	26	-	ns
Rise Time	t _r			-	55.7	-	
Turn-Off Delay Time	t _{d(off)}			-	71	-	
Fall Time	t _f			-	41	-	
Gate Input Resistance	R _g	f = 1 MHz, open drain		-	3.5	-	Ω
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7	
Pulsed Diode Forward Current	I _{SM}			-	-	18	- A
Diode Forward Voltage	V _{SD}	T _{.1} = 25 °C, I _S = 6 A, V _{GS} = 0 V		-	-	1.4	V
Reverse Recovery Time	t _{rr}	-		-	192	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 6 \text{A},$ $dI/dt = 100 \text{A/µs}, V_R = 400 \text{V}$		_	2.4	-	μC
Reverse Recovery Current	I _{RRM}			_	11	<u> </u>	A

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

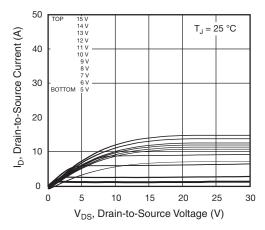


Fig. 1 - Typical Output Characteristics

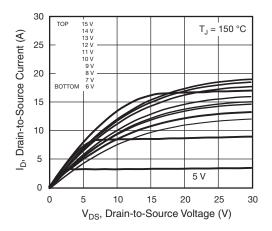


Fig. 2 - Typical Output Characteristics

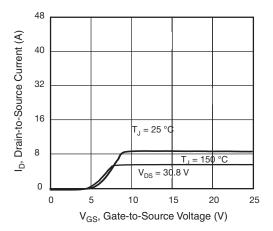


Fig. 3 - Typical Transfer Characteristics

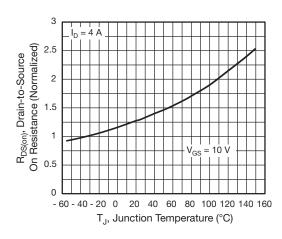


Fig. 4 - Normalized On-Resistance vs. Temperature

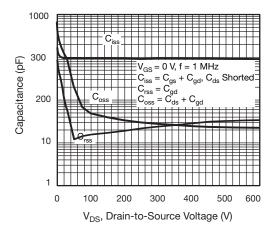


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

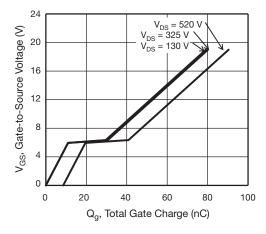


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



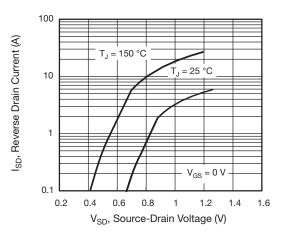


Fig. 7 - Typical Source-Drain Diode Forward Voltage

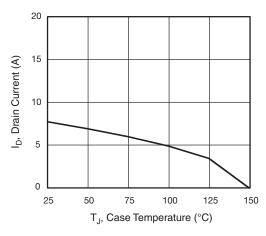


Fig. 9 - Maximum Drain Current vs. Case Temperature

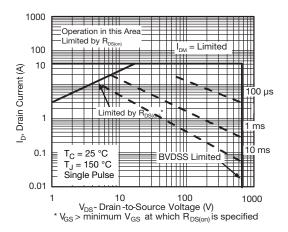


Fig. 8 - Maximum Safe Operating Area

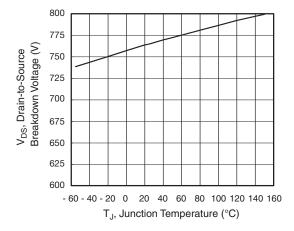


Fig. 10 - Temperature vs. Drain-to-Source Voltage

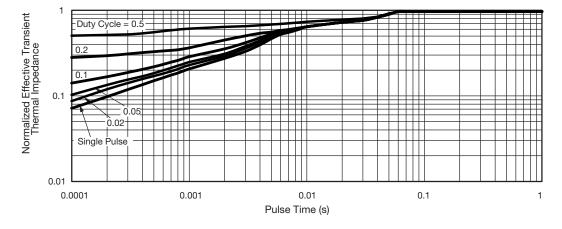


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



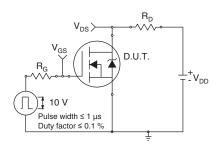


Fig. 12 - Switching Time Test Circuit

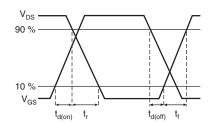


Fig. 13 - Switching Time Waveforms

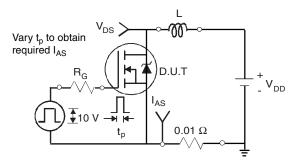


Fig. 14 - Unclamped Inductive Test Circuit

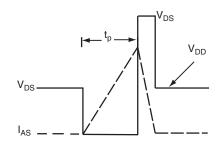


Fig. 15 - Unclamped Inductive Waveforms

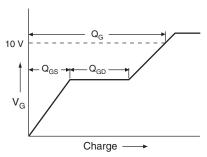


Fig. 16 - Basic Gate Charge Waveform

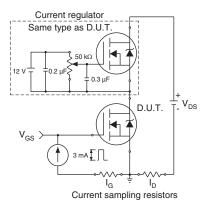
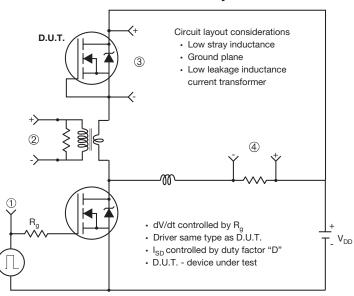


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



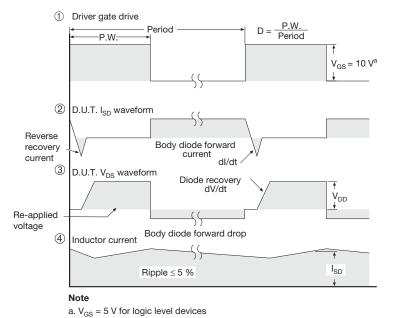


Fig. 18 - For N-Channel



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